FORM PTO-1595 11/06/03 RECOR 11-14	U.S. DEPARTMENT OF COMMERCE
(Rev. 6-93) 1 / 06/0 RECOR 1 1 - 14	- 2003 Patent and Trademark Office
To the Honorable Commissioner of Patent	
1. Name of conveying party(ies): 10260	d original documents or copy thereof.
Joon-hyung Lee	2. Thanke and address of receiving party(les).
Byung-sun Kim	Name: Samsung Electronics, Co., Ltd.
Tae-jung Lee	Internal Address:
Additional name(s) of conveying party(ies) attached?	1088
Additional name(s) of conveying party(ies) attached?   Yes No  No  Nature of conveyance:	Start Address Alfa No. 1 Dill
5. Nature of conveyance:	Street Address: 416, Maetan-dong, Paldal-gu,
M Assignment	Suwon-city, Kyungki-do, Republic of Korea
☑ Assignment ☐ Merger	
☐ Security Agreement ☐ Change of Name	City: State ZIP
□ Other	
Execution Date: October 8 & 9, 2003	Additional name(s) & address attached? ☐ Yes ☒ No
4. Application number(s) or patent number(s):	
If this document is being filed together with a new application, the exec	
A. Patent Application No.(s) 10/702350	B. Patent No.(s)
1011	
Additional numbers attached? □ Yes ☒ No	
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and registrations involved
Name: Steven M. Mills	
	7. Total fee (37 CFR 3.41) \$40.00
Internal Address: MILLS & ONELLO LLP	
	☑ Enclosed
	☐ Authorized to be charged to deposit account
Street Address: Eleven Beacon Street, Suite 605	8. Deposit Account Number:
City D. City MA. 770 00100	
City: Boston State MA ZIP 02108	(Attach duplicate copy of this page if paying by deposit account)
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of firstoment and signature:  40.00 to  To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.	
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Steven M. Mills 36,610	MINULE 11/6/03
Name of Person Signing Signature Date	
Total number of pages including cover sheet, attachments, and document 3	

Mail documents to be recorded with required cover sheet information to: Commissioner of Patents and Trademarks, Box Assignments Washington, D.C. 20231

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Reference No.: SAM-0478

## ASSIGNMENT

We, Joon-hyung Lee, of 107-1101, Cheonggu Apt., Jeongja-dong(Hansol-Maeul), Bundang-gu, Seongnam-city, Kyungki-do, Republic of Korea; Byung-sun Kim, of 301-1102, Poonglim Apt., 1235, Gwonseon-dong, Gwonseon-gu, Suwon-city, Kyungki-do; Tae-jung Lee, of 107-1102, Shinyoungtong Hyundai Apt., Banwol-ri, Taean-eup, Hwaseong-gun, Kyungki-do, Republic of Korea, having invented improvements in CELL STRUCTURE OF EPROM DEVICE AND METHOD FOR FABRICATING THE SAME, described in an application for Letters Patent of the United States, executed by us on even date herewith, for good and valuable consideration, receipt of which is hereby acknowledged from Samsung Electronics Co., Ltd., a Korean corporation having a place of business at 416, Maetan-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic of Korea (and hereinafter called the Assignce, which term shall include its successors and assigns), do hereby sell, assign and transfer unto the Assignee our entire right, title, and interest in and throughout the United States of America (including its territories and dependencies) and all countries foreign thereto, in and to and under said application (which term shall include hereinafter where the context so admits all divisional, continuing, reissue and other patent applications based thereon) and the inventions (which term shall include each and every such invention, or part thereof) therein described, and any and all patents and like rights of exclusion (including extensions thereof) of any country which may be granted on or for said inventions or on said application;

And for the same consideration We do also hereby sell, assign, and transfer unto the Assignee, all our rights under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, and all other treaties of like purpose in respect of said inventions and said application, and We do hereby authorize the Assignee to apply in our name or its own name or its designee for patents and like rights of exclusion on or for said inventions in all countries, claiming (if the Assignee so desires) the priority of the filing date of said application under the provisions of said Convention, Treaty or any such other Convention or Treaty;

And for the same consideration, We do hereby agree for ourselves and for our heirs, executors, and administrators, promptly upon request of the Assignee to execute and deliver without further compensation any power of attorney, assignment, original, divisional, continuing, reissue or other application or applications for patent or patents or like rights of exclusion of any country, or other lawful documents and any further assurances that may be deemed necessary or desirable by the Assignee, fully to secure to it said right, title, and interest as aforesaid in and to said inventions, applications, and said several patents and like rights of exclusion (including extensions thereof) or any of them, all, however, at the expense of the Assignee, its successors, or assigns;

And We do hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America and the corresponding Official of each country foreign thereto to issue to the Assignee, any and all patents and like rights of exclusion which may be granted in any country upon said United States application on or for said inventions;

And We do hereby covenant for ourselves and our legal representatives and agree with the Assignee, that We have granted no right or license to make, use, or sell said inventions to anyone except the Assignee, that prior to the execution of this deed our right, title, and interest in and to said inventions has not been otherwise encumbered by us, and that We have not executed and will not execute any

Page 1 of 2

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Reference No.: SAM-0478

instruments in conflict herewith.

First or Sole Inventor:

Signature:

Joon-Hyung Lee
Joon-hyung Lee

Date: 08. Oct. 2003

Second Joint Inventor:

Byung-Sum Kim

Date: of. Oct, 2003

Third Joint Inventor:

Signature:

Tae-jung Lee
Tae-jung Lee

Date: 9. Qt , 2003

REFERENCE NO.: SAM-0478

Page 2 of 2

**RECORDED: 11/06/2003** REEL: 014681 FRAME: 0997